

Chemical Name	Common Name	Type	Authorized Equipment	Special Considerations
A-174 Silane	Parylene Curing Agent	Adhesion Agent	Parylene Coater	
Acetic Acid	Acetic Acid	Acid	-	
Acetone	Acetone	Solvent	-	Degrades nitrile gloves
Acrylic sheet	Acrylic	Substrate	EBE	
Alumel	Alumel	Deposition Source	EBE	
Aluminum	Al	Deposition Source	EBE	
Aluminum / Silicon / Copper	Al / Si / Cu	Deposition Source	EBE, DC Sputter	
Aluminum / Copper	Al / Cu	Deposition Source	Clustex	
Aluminum Etchant	Aluminum Etchant	Etchant	Clustex	
Aluminum Nitride	Aluminum Nitride	Deposition Source	Light PPE	
Aluminum Oxide	Aluminum Oxide, Al2O3	Deposition Source	RF Sputter	
Ammonium Hydroxide	NH4OH	Cleaning agent	EBE, RF Sputter	
AR 600-546	AR 600-547	EBL Developer	Fume hoods	
AR 600-71	AR 600-72	EBL Stripper		
AR-P 2200.09	EBL Resist	EBL Resist	-	
AZ P4629 Photoresist	AZ P4629 Photoresist	Resist	-	
AZ 300 MIF	AZ 300 MIF	Developer	-	
AZ 400T Stripper	400T	Stripper	-	
AZ 400K Develper	AZ 400K Develper	Developer	-	
AZ 5214 EIR	AZ 5214 EIR	Developer	-	
AZ 726 MIF	AZ 726 MIF	Developer	-	
AZ P4620 Photoresist	AZ P4620	Resist	Laurell, Bidtec spinners	
AZ Devloper 1:2	AZ Devloper 1:2	Developer	-	
AZ 10XT 520CP photoresist	AZ 10XT resist	Resist	Laurell, Bidtec spinners	
Barium Fluoride	BaF2	Deposition Source	EBE, RF sputter	
Buffered Oxide Etch 7:1 Mixture	BOE	Acid	Web bench	
C Thinner	C Thinner	Solvent	EBE	
Cerium Oxide	CeO2	Depost	-	
Chlorobenzene	Chlorobenzene	Solvent	Laurell spinner	
Chloroform	Chloroform	Deposition Source	EBE	
Chromel	Chromel	Deposition Source	EBE, DC Sputter	
Chromium	Cr, Chrome	Etchant	-	
Chromium Etchant	Chromium Etchant	Deposition Source	Clustex	
Chromium Oxide	Cr2O3	Substrate	DC Sputter	
CNT (1-2%) in PVDF composite substrate		Deposition Source	DC Sputter	
Cobalt	Co	Deposition Source	EBE, DC Sputter	
Copper	Cu	Deposition Source	MTL Annealing	
Copper Etchant	Copper Etchant	Etchant	Clustex	
Copper Hydroxide	Cu(OH)2	Powder		
Copper Oxide	Cu2O	Deposition Source		
Cyclopentanone 99%		chemical		PPE Careful disposal How have been disposed so far?
DisChem DisCharge H2O	DisCharge H2O	Coating Agent	Spin coaters	
DPX-C	Parylene Dimer	Coating Agent	Parylene Coater	
EBR 10A	EBR 10A	PB removal agent	Wet bench	
EBR PG	EBR PG	PR removal agent		
Erbium	Er	Deposition Source	EBE, DC Sputter	
Ethyl Lactate		Non-toxic chemicals		
Ferritin		may not be a product name		
Fomblin oil 45	Fomblin	Coating on SiO2/Si wafers	EBE	
Gallium Nitride	GaN	Oil for vacuum pumps	Vacuum pumps	
Germanium	Ge	Deposition Source	EBE, RF Sputter	
Glycerol	Glycerol	Deposition Source	EBE, RF Sputter	
Gold	Ag	alcohol	Web bench	
Gold Etchant	Gold Etchant	Deposition Source	EBE	
Graphite	C, Carbon	Etchant	-	
Hafnium Oxide	HfO2	Substrate	PECVD, RIE	
Hafnium Nitride	HfN	Target	Clustex, RF sputter	
Hexamethyldisilazane	HMDS	Deposition Source	Clustex	
Hexane	Hexane	Resist adhesion promoter	Mask aligners	
Hydrochloric Acid	HCl	solvent	Web bench	
Hydrofluoric Acid 49%	HF	Acid	-	
Hydrogen Peroxide 30%	Peroxide	Acid	PPE Required	
Indium	In	Peroxide	-	
Indium Antimonide	InSb	Deposition Source	RF Sputter	
Indium Oxide / Tin Oxide	IO / TO	Deposition Source	Clustex	
Indium Tin Oxide	ITO	Deposition Source	RF Sputter	
Iron	Fe	Deposition Source	EBE, DC Sputter	
IP-Vizio Photoresist		Nanoscribe resin	Nanoscribe	
IP-Q Photoresist		Nanoscribe resin	Nanoscribe	
IP-Dip Photoresist		Nanoscribe resin	Nanoscribe	
IP-L Photoresist		Nanoscribe resin	Nanoscribe	
IP-S Photoresist		Nanoscribe resin	Nanoscribe	
Iron(III) Oxide Etchant	Iron(III) Oxide Etchant	Etchant	-	
Isopropyl Alcohol	IPA	Solvent	-	
JRD1	JRD1	Coating agent	Spin coaters	
Lithium Niobate	LiNbO3	Substrate	EBE, DC Sputter	
Lithium Tantalum Oxide	LiTaO3	Deposition Source	RF Sputter	
LOR 10A	LOR	photoresist	Spin coaters	
LOR 30B	LOR	photoresist	Spin coaters	
LOR 3A	LOR	photoresist	Spin coaters	
LOR A1	LOR	photoresist	Spin coaters	
Machinable Glass Ceramic	MACOR, Ceramic	Substrate	EBE, DC Sputter, RF Sputter	
Magnesium	Mg	Deposition Source	EBE	
Magnesium Fluoride	MgF2	Deposition Source	EBE	
Ma-N 2410		photoresist	EVG610, MA6, MLA150	
MCC Primer	MCC	adhesion promoter	Spin coaters	
Methanol	Methanol	Solvent	-	
MF CD-26		Developer	Fume hoods	
1-Methyl-2-Pyrrolidinone		solvent		
MBIB:IPA 1:3	EBL Developer	Developer	-	
Microposit MF-319	Microposit MF-320	Developer	-	
MAA(0.5) MAA EL9		Electron resist	spin coaters	
Molybdenum	Mo	Deposition Source	EBE, DC Sputter, Clustex	
Molybdenum Trioxide	MoO3	Deposition Source	RF Sputter, Clustex	
Nanostrip		Alternative to piranha solution	Wet bench	
Nickel Etchant	Nickel Etchant, Ferric Chloride	Etchant	-	
Nickel Oxide	NiO	Deposition Source	Clustex	
Niobium	Nb	Deposition Source	DC Sputter	
Niobium Nitride	NbN	Deposition Source	RF Sputter, Clustex	
Niobium Oxide	NbO	Deposition Source	Clustex	
Nitric Acid	Nitric Acid	Acid	-	
Novec 7100		solvent	PPE Required	
NR7		Negative resist	spin coaters	
NR 9-1000PY		Negative resist	spin coaters	
NR9-1500PY		Negative resist	spin coaters	
NR9-3000PY		Negative resist	spin coaters	
NR9-6000PY		Negative resist	spin coaters	
NR26-12000P		Negative resist	spin coaters	
NR78-3000P		Negative resist	spin coaters	
NCM, Carbon Black, and PVDF film	NCM is composed of metal oxides; PVDF is an ethene, 1,1-difluoro-, homopolymer	Film on Al foil (not powders)	4-pt probe	

P(VDF-TrFE-CTFE), BaTiO3/PVDF composite (BaTiO3 20%wt), and BaTiO3/P(VDF-TrFE-CTFE) composite (BaTiO3 20%wt) substrates		Substrates	DC Sputter	
Omnicoat	Omnicoat	Adhesion promoter/releaser for SU8	Wet bench	PPE Required
Palladium	Pd	Deposition Source	DC Sputter	
Perminex 2015	Perminex 2015	Negative resist	EVG610, M46, MLA150	
Phosphoric Acid	Phosphoric Acid	Acid	-	PPE Required
Poly(acrylic acid)	PAA	Acidic cleaning agent		
Platinum	Pt	Deposition Source	EBE, DC Sputter	
Polydimethylsiloxane	PDMS	Solvent	-	
Polyether ether ketone	PEEK	Shadow mask	EBE	
Poly (methyl methacrylate)	PMMA	EBL Resist, substrate	EBL, Leskers	Depositions must be unheated
Polyethylene Terephthalate	PET	Substrate	RF Sputter	
Polystyrene	PS	Substrate	RF Sputter	
Polystyrene microspheres		Substrate, Deposition Source	Tegal asher	Greater than or equal to 1 micron in size
Potassium Hydroxide	KOH	Etchant	-	
Propylene Glycol Methyl Ether Acetate	PGMEA, NanoScribe Developer	Developer	-	
Polyvinylidene Difluoride	PFDF	Substrate	EBE, DC Sputter, RF Sputter	No substrate heating
RD6	RD6	Resist developer	Web bench	
Rhodium	Rh	Deposition Source	DC Sputter	
Ruthenium	Ru	Deposition Source	DC Sputter	
Ruthenium Oxide	RuO2	Deposition Source	Clustex	
S1818	S1819	Photoresist		
Scandium	Sc	Deposition Source	EBE2 only	
Silicon	Si	Substrate, Deposition Source	EBE, DC Sputter, RF Sputter, Clustex	
Silicon Nitride	SiNx	Deposition Source	Clustex	
Silicon Dioxide	SiO2	Deposition Source	EBE, RF Sputter	
Silicon Monoxide	SiO	Deposition Source	EBE	
Silver	Ag	Deposition Source	Clustex, EBE, DC Sputter	
SU-8	SU-8	Photoresist	-	
SU-8 developer	SU-8 Developer	Developer	Fume hoods	
Sulfuric Acid	Sulfuric Acid	Acid	-	PPE Required
Sylgard 184 Silicone Elastomer	Sylgard 184 Silicone Elastomer	Transparent Encapsulant		
Sylgard Curing Agent	Sylgard Curing Agent	Transparent Encapsulant		
Tantalum	Ta	Deposition Source	EBE, DC Sputter	
Tantalum / Aluminum	Ta / Al	Deposition Source	Clustex	
Tantalum Carbide	TaC	Deposition Source	Clustex	
Tantalum Nitride	TaN	Deposition Source	RF Sputter	
Tantalum Oxide (Ta2O5)	TaO5	Deposition Source	Clustex, RF sputter, EBE	
Tantalum Oxide (Ta1.8)	Ta1.8	Deposition Source	Clustex	
Tantalum Oxide (Ta02)	Ta02	Deposition Source	Clustex	
Tantalum Oxide(Ta02.2)	Ta02.2	Deposition Source	Clustex	
Tantalum Silicide	TiSi2	Deposition Source	Clustex	
Tetramethylammonium Hydroxide	TMAH, TMAOH	Developer	-	PPE Required
Titanium	Ti	Deposition Source	EBE, DC Sputter	
Titanium Carbide	TiC	Deposition Source	Clustex	
Titanium Etchant	TiEtch	Etchant	-	PPE Required
Titanium Nitride	TiN, Ti-Nitride	Deposition Source	RF Sputter	
Titanium Oxide	TiO, Ti-Oxide	Deposition Source	EBE, Clustex	
Titanium Dioxide	TiO2	Deposition Source	EBE, Clustex, Lesker RF	
Trichloroethylene	TCE	Solvent	-	
(TRIDECAFLUORO-	Trichlor	Solvent	Fume hoods	
1,1,2,2TETRAHYDROOCTYL)TRICHLOROSILANE	Toluene	Solvent	Bidtec, fume hoods	Ventilation Required
Toluene	Toluene	Deposition Source	DC Sputter	
Tungsten	W	Deposition Source	Clustex	
Tungsten Oxide	W2O5	Deposition Source	-	
Turpentine Oil	Turpentine, Oil of Turpentine	Solvent		
Vanadium Oxide	VO	Deposition Source	Clustex	
Xylene	Xylene	Solvent	-	
Ytterbium	Yb	Deposition Source	EBE	
ZDMAC	ZDMAC	EBL Stripper	-	
ZED-N50	ZED-N51	EBL Developer	-	
ZEP520	ZEP521	EBL Resist	-	
Zinc Oxide	ZnO	Deposition Source	RF Sputter	
Zirconium	Zr	Deposition Source	DC Sputter	
Zirconium Oxide	Zirconia, ZrO2	Deposition Source	Clustex	